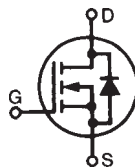


## High Voltage Power MOSFET

**IXTA05N100HV**  
**IXTA05N100**  
**IXTP05N100**

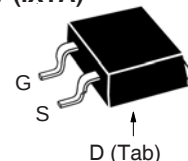
$V_{DSS} = 1000V$   
 $I_{D25} = 750mA$   
 $R_{DS(on)} \leq 17\Omega$

N-Channel Enhancement Mode  
Avalanche Rated

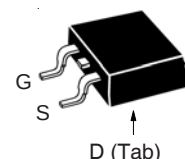


| Symbol        | Test Conditions                                                 | Maximum Ratings |            |
|---------------|-----------------------------------------------------------------|-----------------|------------|
| $V_{DSS}$     | $T_J = 25^\circ C$ to $150^\circ C$                             | 1000            | V          |
| $V_{DGR}$     | $T_J = 25^\circ C$ to $150^\circ C$ , $R_{GS} = 1M\Omega$       | 1000            | V          |
| $V_{GSS}$     | Continuous                                                      | $\pm 30$        | V          |
| $V_{GSM}$     | Transient                                                       | $\pm 40$        | V          |
| $I_{D25}$     | $T_C = 25^\circ C$                                              | 750             | mA         |
| $I_{DM}$      | $T_C = 25^\circ C$ , Pulse Width Limited by $T_{JM}$            | 3               | A          |
| $I_A$         | $T_C = 25^\circ C$                                              | 1               | A          |
| $E_{AS}$      | $T_C = 25^\circ C$                                              | 100             | mJ         |
| $dv/dt$       | $I_S \leq I_{DM}$ , $V_{DD} \leq V_{DSS}$ , $T_J = 150^\circ C$ | 3               | V/ns       |
| $P_D$         | $T_C = 25^\circ C$                                              | 40              | W          |
| $T_J$         |                                                                 | -55 ... +150    | $^\circ C$ |
| $T_{JM}$      |                                                                 | 150             | $^\circ C$ |
| $T_{stg}$     |                                                                 | -55 ... +150    | $^\circ C$ |
| $T_L$         | Maximum Lead Temperature for Soldering                          | 300             | $^\circ C$ |
| $T_{SOLD}$    | 1.6 mm (0.062in.) from Case for 10s                             | 260             | $^\circ C$ |
| $M_d$         | Mounting Torque (TO-220)                                        | 1.13 / 10       | Nm/lb.in   |
| <b>Weight</b> | TO-220                                                          | 3.0             | g          |
|               | TO-263                                                          | 2.5             | g          |
|               | TO-263HV                                                        | 2.5             | g          |

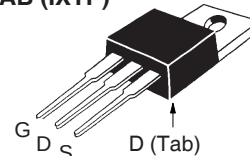
TO-263HV (IXTA)



TO-263 AA (IXTA)



TO-220AB (IXTP)



G = Gate      D = Drain  
S = Source    Tab = Drain

### Features

- High Voltage Package (TO-263HV)
- Fast Switching Times
- Avalanche Rated
- $R_{ds(on)}$  HDMOS™ Process
- Rugged Polysilicon Gate Cell structure
- Extended FBSOA

### Advantages

- High Power Density
- Space Savings

### Applications

- Switch-Mode and Resonant-Mode Power Supplies
- Flyback Inverters
- DC Choppers

| Symbol       | Test Conditions<br>( $T_J = 25^\circ C$ , Unless Otherwise Specified) | Characteristic Values |      |                           |
|--------------|-----------------------------------------------------------------------|-----------------------|------|---------------------------|
|              |                                                                       | Min.                  | Typ. | Max.                      |
| $BV_{DSS}$   | $V_{GS} = 0V$ , $I_D = 250\mu A$                                      | 1000                  |      | V                         |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$ , $I_D = 250\mu A$                                  | 2.5                   |      | 4.5 V                     |
| $I_{GSS}$    | $V_{GS} = \pm 30V$ , $V_{DS} = 0V$                                    |                       |      | $\pm 100$ nA              |
| $I_{DSS}$    | $V_{DS} = V_{DSS}$ , $V_{GS} = 0V$<br>$T_J = 125^\circ C$             |                       |      | 25 $\mu A$<br>500 $\mu A$ |
| $R_{DS(on)}$ | $V_{GS} = 10V$ , $I_D = 375mA$ , Note 1                               |                       |      | 17 $\Omega$               |

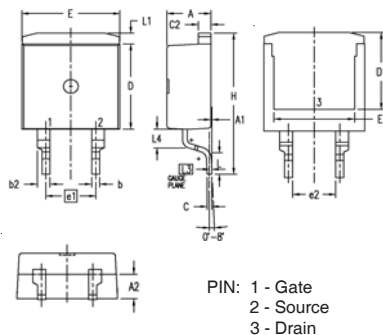
| Symbol                    | Test Conditions                                                                                                                                              | Characteristic Values |      |          |
|---------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|------|----------|
|                           | (T <sub>J</sub> = 25°C, Unless Otherwise Specified)                                                                                                          | Min.                  | Typ. | Max.     |
| <b>g<sub>fs</sub></b>     | V <sub>DS</sub> = 20V, I <sub>D</sub> = 500mA, Note 1                                                                                                        | 0.55                  | 0.93 | S        |
| <b>C<sub>iss</sub></b>    | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz                                                                                                        |                       | 260  | pF       |
| <b>C<sub>oss</sub></b>    |                                                                                                                                                              |                       | 22   | pF       |
| <b>C<sub>rss</sub></b>    |                                                                                                                                                              |                       | 8    | pF       |
| <b>t<sub>d(on)</sub></b>  | <b>Resistive Switching Times</b><br>V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 1A<br>R <sub>G</sub> = 47Ω (External) |                       | 11   | ns       |
| <b>t<sub>r</sub></b>      |                                                                                                                                                              |                       | 19   | ns       |
| <b>t<sub>d(off)</sub></b> |                                                                                                                                                              |                       | 40   | ns       |
| <b>t<sub>f</sub></b>      |                                                                                                                                                              |                       | 28   | ns       |
| <b>Q<sub>g(on)</sub></b>  | V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 1A                                                                        |                       | 7.8  | nC       |
| <b>Q<sub>gs</sub></b>     |                                                                                                                                                              |                       | 1.4  | nC       |
| <b>Q<sub>gd</sub></b>     |                                                                                                                                                              |                       | 4.1  | nC       |
| <b>R<sub>thJC</sub></b>   | (TO-220)                                                                                                                                                     |                       |      | 3.1 °C/W |
| <b>R<sub>thCS</sub></b>   |                                                                                                                                                              | 0.50                  |      | °C/W     |

### Source-Drain Diode

| Symbol                | Test Conditions                                                                                   | Characteristic Values |      |        |
|-----------------------|---------------------------------------------------------------------------------------------------|-----------------------|------|--------|
|                       | (T <sub>J</sub> = 25°C, Unless Otherwise Specified)                                               | Min.                  | Typ. | Max.   |
| <b>I<sub>S</sub></b>  | V <sub>GS</sub> = 0V                                                                              |                       |      | 750 mA |
| <b>I<sub>SM</sub></b> | Repetitive, Pulse Width Limited by T <sub>JM</sub>                                                |                       |      | 3 A    |
| <b>V<sub>SD</sub></b> | I <sub>F</sub> = I <sub>S</sub> , V <sub>GS</sub> = 0V, Note 1                                    |                       |      | 1.5 V  |
| <b>t<sub>rr</sub></b> | I <sub>F</sub> = I <sub>S</sub> , -di/dt = 100A/μs<br>V <sub>R</sub> = 100V, V <sub>GS</sub> = 0V |                       | 710  | ns     |

Note 1: Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

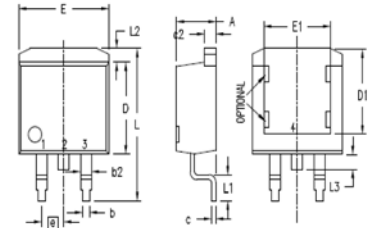
### TO-263HV Outline



PIN: 1 - Gate  
2 - Source  
3 - Drain

| SYM  | INCHES |      | MILLIMETER |       |
|------|--------|------|------------|-------|
|      | MIN    | MAX  | MIN        | MAX   |
| A    | .170   | .185 | 4.30       | 4.70  |
| A1   | .000   | .008 | 0.00       | 0.20  |
| A2   | .091   | .098 | 2.30       | 2.50  |
| b    | .028   | .035 | 0.70       | 0.90  |
| b2   | .046   | .054 | 1.18       | 1.38  |
| C    | .018   | .024 | 0.45       | 0.60  |
| C2   | .049   | .055 | 1.25       | 1.40  |
| D    | .354   | .370 | 9.00       | 9.40  |
| D1   | .311   | .327 | 7.90       | 8.30  |
| E    | .386   | .402 | 9.80       | 10.20 |
| E1   | .307   | .323 | 7.80       | 8.20  |
| e1   | .200   | BSC  | 5.08       | BSC   |
| (e2) | .163   | .174 | 4.13       | 4.43  |
| H    | .591   | .614 | 15.00      | 15.60 |
| L    | .079   | .102 | 2.00       | 2.60  |
| L1   | .039   | .055 | 1.00       | 1.40  |
| L3   | .010   | BSC  | 0.254      | BSC   |
| (L4) | .071   | .087 | 1.80       | 2.20  |

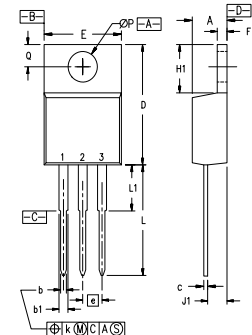
### TO-263AA Outline



PIN: 1 - Gate  
2,4 - Source  
3 - Drain

| SYM | INCHES |      | MILLIMETERS |       |
|-----|--------|------|-------------|-------|
|     | MIN    | MAX  | MIN         | MAX   |
| A   | .160   | .190 | 4.06        | 4.83  |
| A1  | .080   | .110 | 2.03        | 2.79  |
| b   | .020   | .039 | 0.51        | 0.99  |
| b2  | .045   | .055 | 1.14        | 1.40  |
| c   | .016   | .029 | 0.40        | 0.74  |
| c2  | .045   | .055 | 1.14        | 1.40  |
| D   | .340   | .390 | 8.64        | 9.65  |
| D1  | .315   | .350 | 8.00        | 8.89  |
| E   | .380   | .410 | 9.65        | 10.41 |
| E1  | .245   | .320 | 6.22        | 8.13  |
| e   | .100   | BSC  | 2.54        | BSC   |
| L   | .575   | .625 | 14.61       | 15.88 |
| L1  | .090   | .110 | 2.29        | 2.79  |
| L2  | .040   | .055 | 1.02        | 1.40  |
| L3  | .050   | .070 | 1.27        | 1.78  |
| L4  | 0      | .005 | 0           | 0.13  |

### TO-220AB Outline



Pins: 1 - Gate  
3 - Source  
2 - Drain

| SYM | INCHES |      | MILLIMETERS |       |
|-----|--------|------|-------------|-------|
|     | MIN    | MAX  | MIN         | MAX   |
| A   | .170   | .190 | 4.32        | 4.83  |
| b   | .025   | .040 | 0.64        | 1.02  |
| b1  | .045   | .065 | 1.15        | 1.65  |
| c   | .014   | .022 | 0.35        | 0.56  |
| D   | .580   | .630 | 14.73       | 16.00 |
| E   | .390   | .420 | 9.91        | 10.66 |
| e   | .100   | BSC  | 2.54        | BSC   |
| F   | .045   | .055 | 1.14        | 1.40  |
| H1  | .230   | .270 | 5.85        | 6.85  |
| J1  | .090   | .110 | 2.29        | 2.79  |
| k   | 0      | .015 | 0           | 0.38  |
| L   | .500   | .550 | 12.70       | 13.97 |
| L1  | .110   | .230 | 2.79        | 5.84  |
| ØP  | .139   | .161 | 3.53        | 4.08  |
| Q   | .100   | .125 | 2.54        | 3.18  |

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2  
by one or more of the following U.S. patents: 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2  
4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$

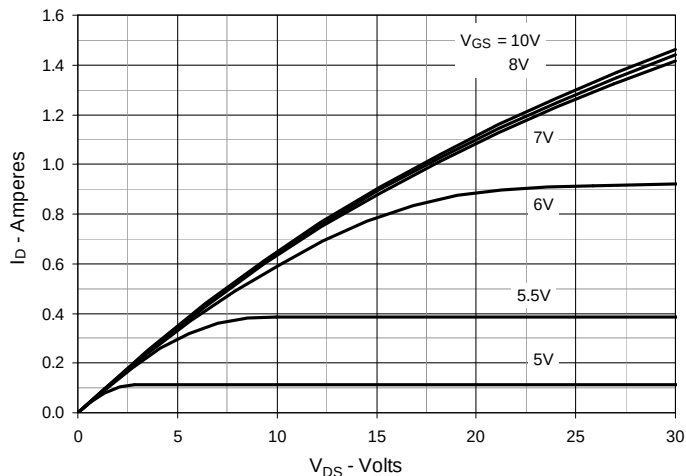


Fig. 2. Output Characteristics @  $T_J = 125^\circ\text{C}$

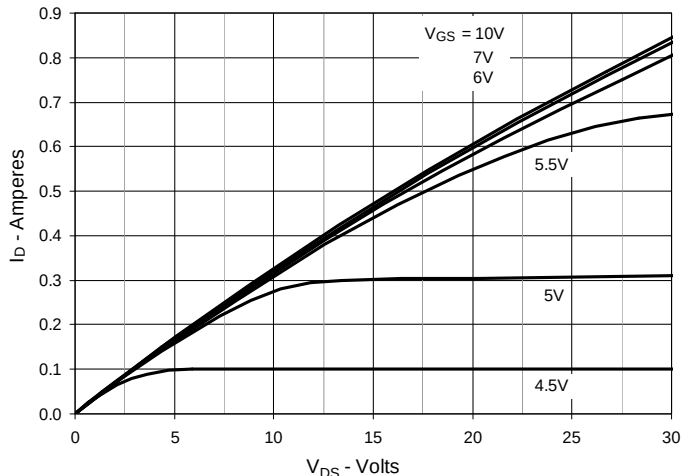


Fig. 3.  $R_{DS(on)}$  Normalized to  $I_D = 375\text{mA}$  Value vs. Junction Temperature

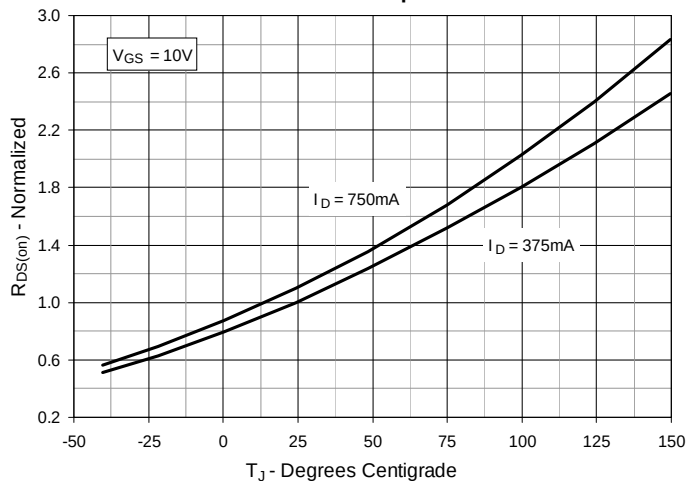


Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 375\text{mA}$  Value vs. Drain Current

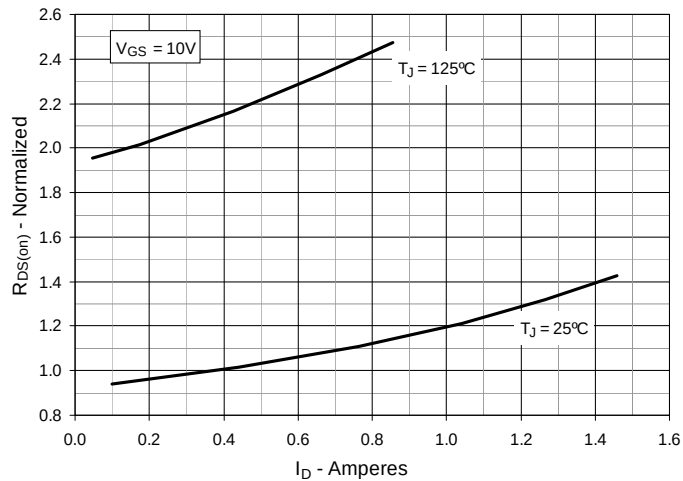


Fig. 5. Maximum Drain Current vs. Case Temperature

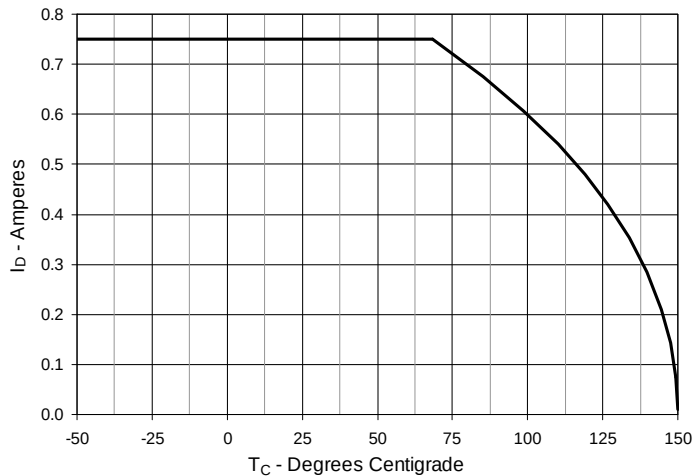
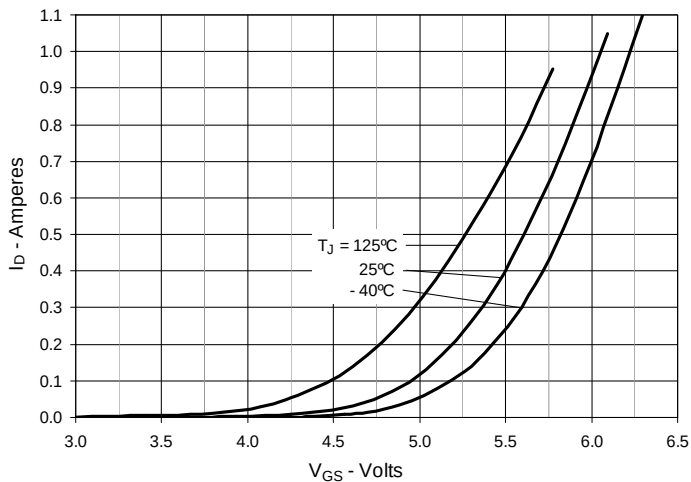
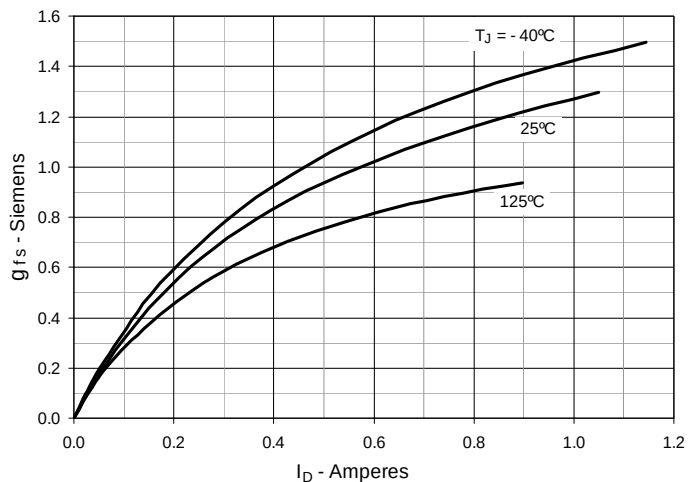


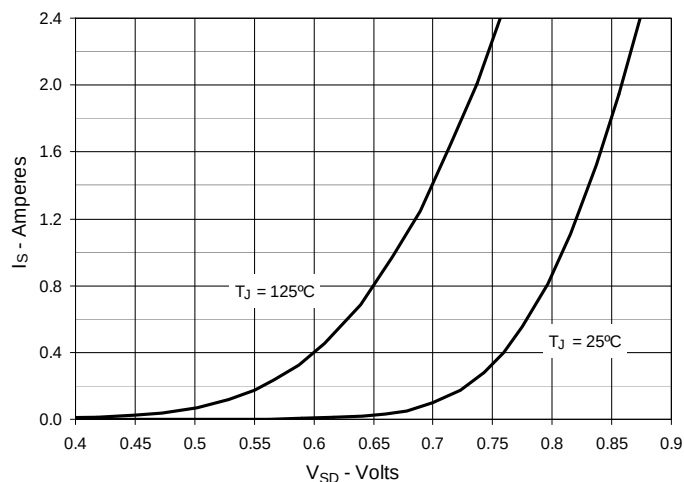
Fig. 6. Input Admittance



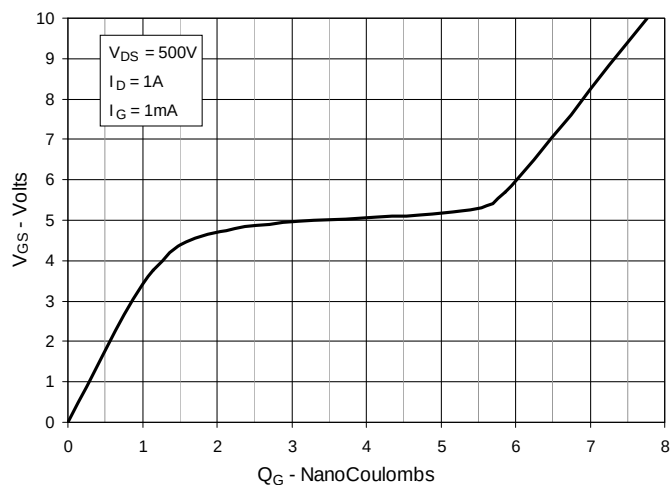
**Fig. 7. Transconductance**



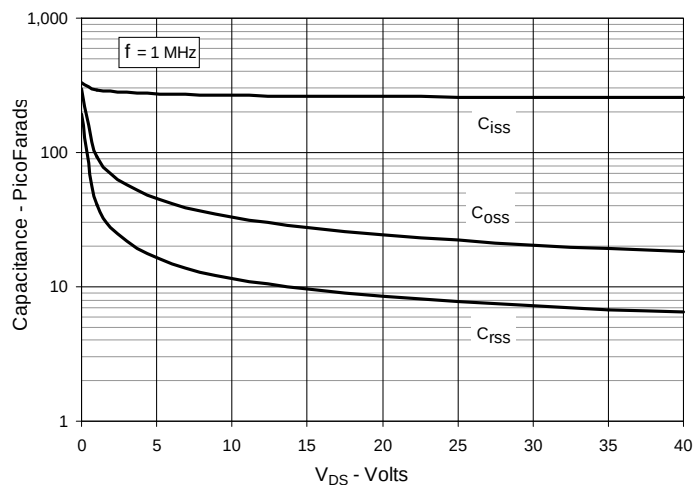
**Fig. 8. Forward Voltage Drop of Intrinsic Diode**



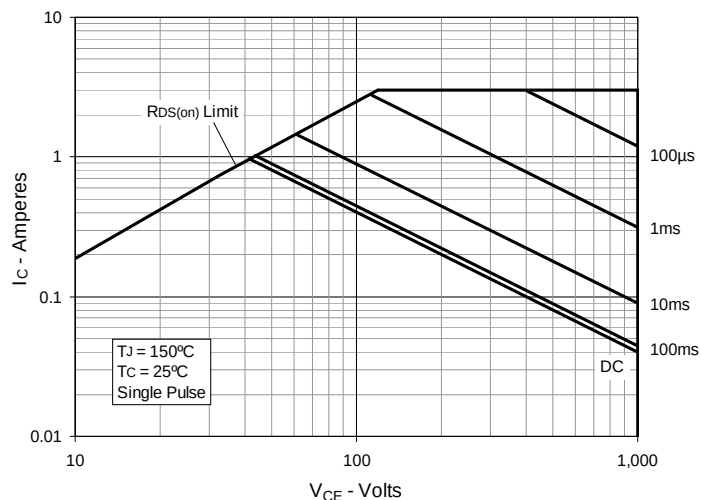
**Fig. 9. Gate Charge**



**Fig. 10. Capacitance**



**Fig. 11. Forward-Bias Safe Operating Area @  $T_C = 25^\circ\text{C}$**



**Fig. 12. Forward-Bias Safe Operating Area @  $T_C = 75^\circ\text{C}$**

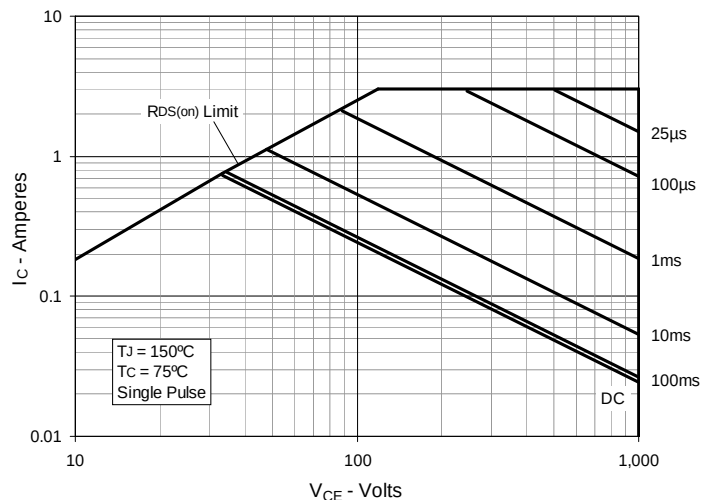


Fig. 13. Maximum Transient Thermal Impedance

